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Texas Instruments SN74BCT2245DBR

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### Distributor of Texas Instruments: Excellent Integrated System Limited Datasheet of SN74BCT2245DBR - IC TRANSCVR TRI-ST 8BIT 20SSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

### SN74BCT2245 **OCTAL TRANSCEIVER AND LINE/MOS DRIVER** WITH 3-STATE OUTPUTS

**DB, DW, N, OR NS PACKAGE** (TOP VIEW)

DIR

A1 [

A2

A3

2

3

4 A4

5

**[**9 A8

10

A5 🛛 6

A6 🛛 7

Α7 П 8

GND

SCBS102C - FEBRUARY 1992 - REVISED MARCH 2003

V<sub>CC</sub> 20

I OE

**B**1

16 🛛 B3

15 🛛 B4

14 🛛 B5

13 🛛 B6

12 🛛 B7

11 B8

19

18

17 П в2

- Operating Voltage Range of 4.5 V to 5.5 V
- State-of-the-Art BiCMOS Design Significantly Reduces I<sub>CCZ</sub>
- B Port Has Equivalent 33-Ω Series **Resistors, So No External Resistors** Are Required
- ESD Protection Exceeds JESD 22 - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

### description/ordering information

The SN74BCT2245 octal transceiver and line/ MOS driver is designed for asynchronous communication between data buses.

The device allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (OE) input can disable the devices so that both buses are effectively isolated.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The B-port outputs, which are designed to source or sink up to 12 mA, include 33-Ω series resistors to reduce overshoot and undershoot.

T <sub>A</sub>	PACKA	GE <sup>†</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube	SN74BCT2245N	SN74BCT2245N
		Tube	SN74BCT2245DW	DOTO0 (F
0°C to 70°C	SOIC – DW	Tape and reel	SN74BCT2245DWR	BCT2245
	SOP – NS	Tape and reel	SN74BCT2245NSR	BCT2245
	SSOP – DB	Tape and reel	SN74BCT2245DBR	BA245

### **ORDERING INFORMATION**

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

#### FUNCTION TABLE

INP	UTS	
OE	DIR	OPERATION
L	L	B data to A bus
L	н	A data to B bus
н	Х	Isolation



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



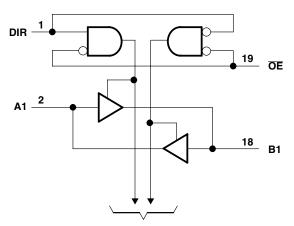
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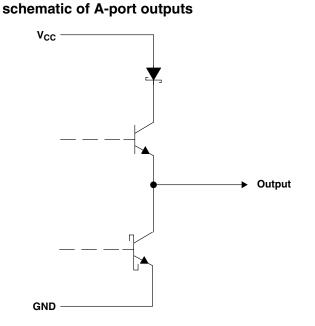
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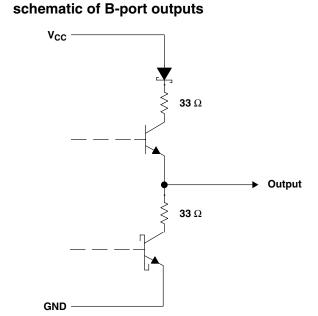
### SN74BCT2245 OCTAL TRANSCEIVER AND LINE/MOS DRIVER WITH 3-STATE OUTPUTS SCBS102C - FEBRUARY 1992 - REVISED MARCH 2003

logic diagram (positive logic)



To Seven Other Channels





All resistor values shown are nominal.





## SN74BCT2245 OCTAL TRANSCEIVER AND LINE/MOS DRIVER WITH 3-STATE OUTPUTS

SCBS102C - FEBRUARY 1992 - REVISED MARCH 2003

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, V <sub>CC</sub>		–0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)		
Voltage range applied to any output in the disa	abled or power-off state, $V_O$	
Voltage range applied to any output in the high	n state, V <sub>O</sub>	
Input clamp current, IIK		
Current into any output in the low state, Io		60 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2)	: DB package	
	DW package	
	N package	
	NS package	
Storage temperature range, T <sub>stg</sub>		−65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

### recommended operating conditions (see Note 3)

			MIN	NOM	MAX	UNIT
V <sub>CC</sub>	Supply voltage		4.5	5	5.5	V
V <sub>IH</sub>	High-level input voltage		2			V
$V_{\text{IL}}$	Low-level input voltage				0.8	V
I <sub>IK</sub>	Input clamp current			-18	mA	
		A port			-3	
I <sub>ОН</sub>	High-level output current B port				-12	mA
		A port			24	
IOL	Low-level output current			12	mA	
T <sub>A</sub>	Operating free-air temperature		0		70	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.





### SN74BCT2245 OCTAL TRANSCEIVER AND LINE/MOS DRIVER WITH 3-STATE OUTPUTS SCBS102C - FEBRUARY 1992 - REVISED MARCH 2003

SCBS102C - FEBRUARY 1992 - REVISED MARCH 2003

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CONDITIONS	MIN	TYP <sup>†</sup>	MAX	UNIT		
V <sub>IK</sub>		$V_{CC} = 4.5 V,$	I <sub>I</sub> = -18 mA			-1.2	V		
	A		$I_{OH} = -1 \text{ mA}$	2.5	3.4				
.,	A port	V <sub>CC</sub> = 4.5 V	$I_{OH} = -3 \text{ mA}$	2.4	3.3		.,		
V <sub>OH</sub>	Burt	N 45 M	$I_{OH} = -1 \text{ mA}$	2.4	3.3		V		
	B port	V <sub>CC</sub> = 4.5 V	I <sub>OH</sub> = -12 mA	2	3.2				
	A port	V <sub>CC</sub> = 4.5 V,	I <sub>OL</sub> = 24 mA		0.35	0.5			
VOL	Burt	N 45 M	I <sub>OL</sub> = 1 mA			0.5	V		
	B port	B port $V_{CC} = 4.5 V$	I <sub>OL</sub> = 12 mA			0.8			
I <sub>I</sub>		V <sub>CC</sub> = 5.5 V,	V <sub>1</sub> = 5.5 V			0.1	mA		
. +	A or B port		N 07N			70			
IIH‡	Control input	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 2.7 V			20	μA		
I <sub>IL</sub> ‡		V <sub>CC</sub> = 5.5 V,	V <sub>1</sub> = 0.5 V			-0.65	mA		
	A port			-60		-150			
I <sub>OS</sub> §	B port	V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 0	-100		-225	mA		
	A to B				63	100			
ICCL	B to A	V <sub>CC</sub> = 5.5 V,	Outputs open		40	64	mA		
	A to B				37	59			
ICCH	B to A	$V_{\rm CC} = 5.5  \rm V,$	Outputs open		29	46	mA		
_	A to B				9	15	-		
I <sub>CCZ</sub>	B to A	V <sub>CC</sub> = 5.5 V,	Outputs open		8	14	mA		
Ci	Control input	V <sub>CC</sub> = 5 V,	V <sub>I</sub> = 2.5 V or 0.5 V		7		pF		
	A to B				9				
Cio	B to A	$V_{\rm CC} = 5  \rm V,$	$V_{O} = 2.5 \text{ V} \text{ or } 0.5 \text{ V}$		12		pF		

 $^{\dagger}$  All typical values are at V\_{CC} = 5 V, T\_{A} = 25°C.

 $\ddagger$  For I/O ports, the parameters  $I_{\text{IH}}$  and  $I_{\text{IL}}$  include the off-state output current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

# switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

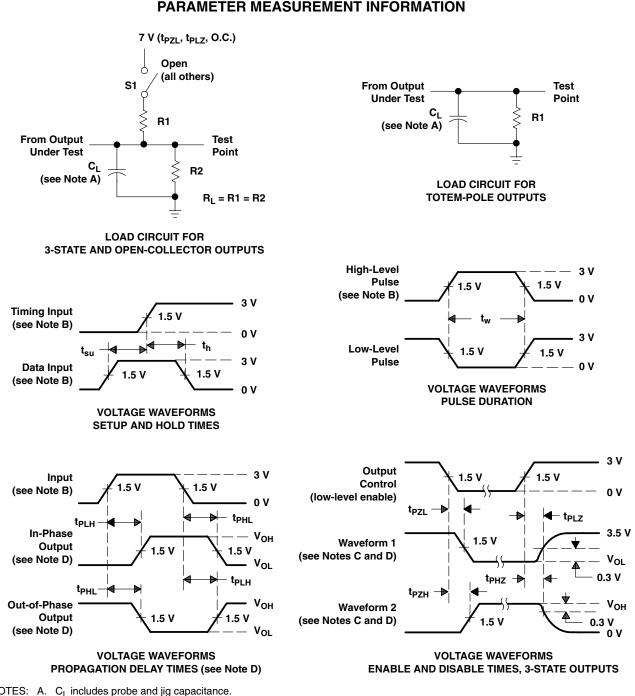
PARAMETER	FROM	TO	V. T	<sub>CC</sub> = 5 V <sub>A</sub> = 25°C		MIN	МАХ	UNIT
	(INPUT)	(OUTPUT)	MIN	ТҮР	MAX			
	А	В	1	3.3	4.9	1	5.8	
<sup>t</sup> PLH	В	А	1.7	4.2	6.1	1.7	7	ns
	А	В	2.5	5.1	6.9	2.5	7.8	
t <sub>PHL</sub>	В	А	2.2	4.7	7.1	2.2	7.7	ns
		В	3.2	6.2	8.6	3.2	9.9	
<sup>t</sup> PZH	ŌĒ	А	3.8	7.2	9.5	3.8	11.1	ns
		В	5.6	8.3	10.9	5.6	12.2	
t <sub>PZL</sub>	ŌĒ	А	4.2	7.6	10.1	4.2	11.4	ns
	<u>AE</u>	В	2.6	5.2	7.1	2.6	8.2	
t <sub>PHZ</sub>	ŌĒ	А	3.1	5.7	8	3.1	9.4	ns
+		В	3.5	6	7.9	3.5	9.2	20
t <sub>PLZ</sub>	ŌĒ	А	2.3	4.7	6.5	2.3	7.6	ns





### SN74BCT2245 **OCTAL TRANSCEIVER AND LINE/MOS DRIVER** WITH 3-STATE OUTPUTS

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NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, t<sub>r</sub> = t<sub>f</sub>  $\leq$  2.5 ns, duty cycle = 50%. C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
- Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. The outputs are measured one at a time with one transition per measurement.
- E. When measuring propagation delay times of 3-state outputs, switch S1 is open.
- F. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms





24-Sep-2015

#### PACKAGING INFORMATION

www.ti.com

Orderable Device	Status	Package Type		Pins		Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
SN74BCT2245DBLE	OBSOLETE	SSOP	DB	20		TBD	Call TI	Call TI	0 to 70		
SN74BCT2245DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	BCT2245	Samples
SN74BCT2245DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	BCT2245	Samples
SN74BCT2245DWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	BCT2245	Samples
SN74BCT2245NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	BCT2245	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs. LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Ti's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width

Addendum-Page 1



24-Sep-2015

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Addendum-Page 2



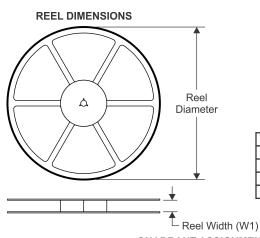
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TEXAS INSTRUMENTS

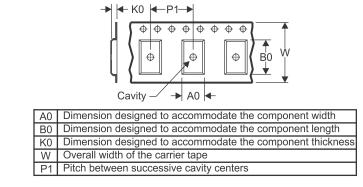
# PACKAGE MATERIALS INFORMATION

17-Apr-2015

### TAPE AND REEL INFORMATION

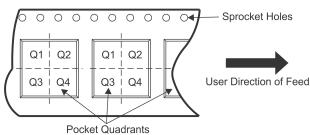


\*All dimensions are nominal



TAPE DIMENSIONS

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74BCT2245DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74BCT2245NSR	SO	NS	20	2000	330.0	24.4	9.0	13.0	2.4	4.0	24.0	Q1



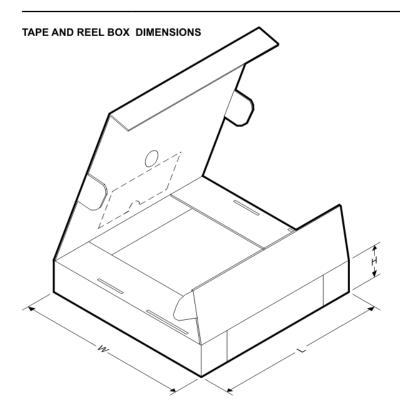
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## PACKAGE MATERIALS INFORMATION

17-Apr-2015



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74BCT2245DWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74BCT2245NSR	SO	NS	20	2000	367.0	367.0	45.0



**DW0020A** 

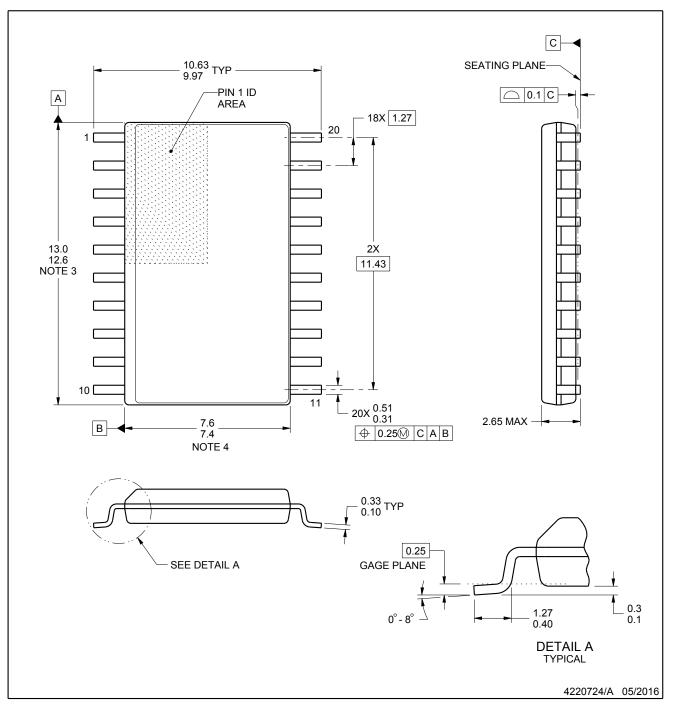
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# PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.





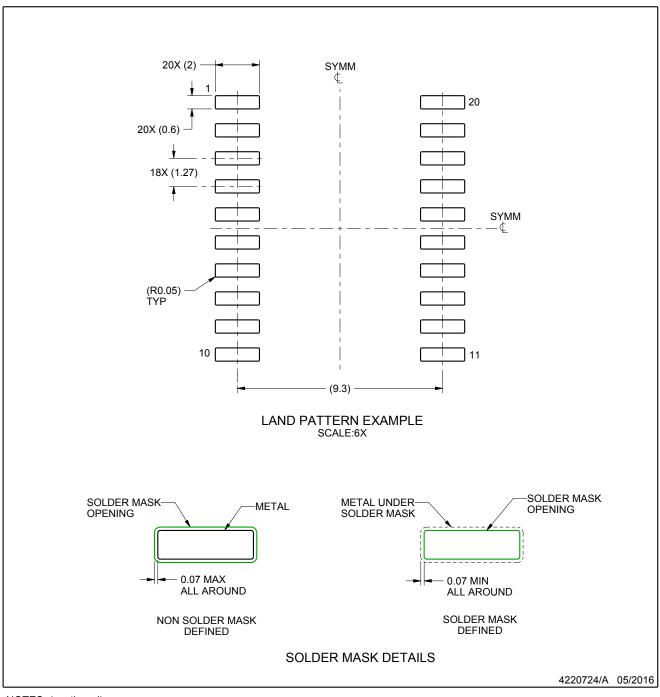
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# **EXAMPLE BOARD LAYOUT**

## SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





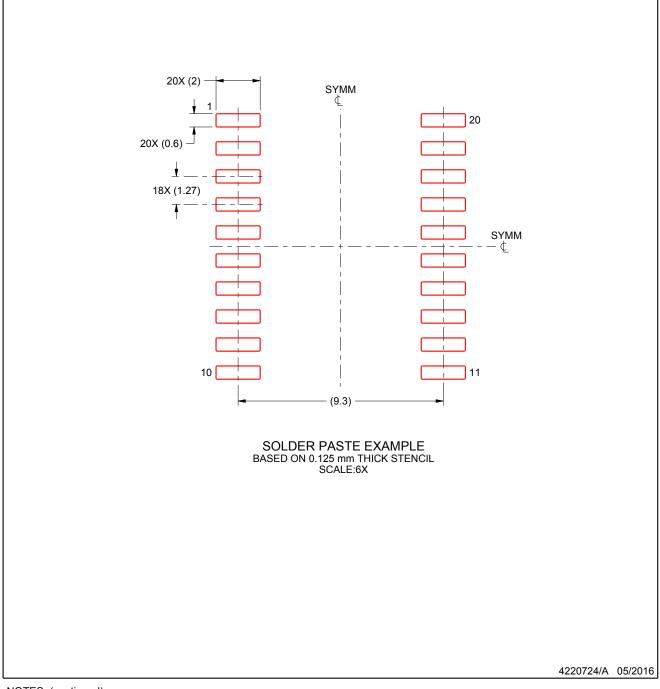
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# **EXAMPLE STENCIL DESIGN**

### SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.





## **MECHANICAL DATA**

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

#### DB (R-PDSO-G\*\*) PLASTIC SMALL-OUTLINE **28 PINS SHOWN** 0,38 0,65 $\oplus$ 0,15 M 0,22 28 15 0,25 0,09 8,20 5,60 5,00 7,40 $\bigcirc$ Gage Plane **0**,25 1 14 0 0,95 0,55 Seating Plane △ 0,10 2,00 MAX 0,05 MIN PINS \*\* 24 14 16 20 28 30 38 DIM 6,50 8,50 10,50 10,50 12,90 A MAX 6,50 7,50 A MIN 5,90 5,90 6,90 7,90 9,90 9,90 12,30 4040065 /E 12/01

NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150



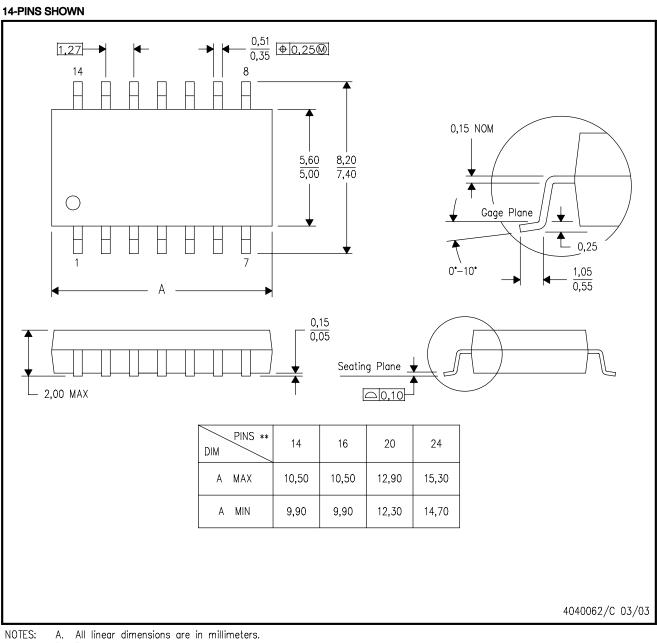


NS (R-PDSO-G\*\*)

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### MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE



B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.





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